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# H8/300L SLP Series

### Example of Receiving Remote Control Signals in Power-Saving Modes

#### Introduction

Signals received by an infrared remote control receiver are used as interrupt input to shift the mode of the microcomputer from standby to active, then it receives data from the infrared remote controller.

#### Target Device

H8/38024

#### Contents

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#### 1. Specifications

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- 1. Figure 1 shows a hardware configuration required to receive infrared remote control data using an infrared remote control receiver.
- 2. In this sample task, infrared remote control signals are used to shift the mode of the microcomputer from standby, one of the power-saving modes of the microcomputer to the active mode, in which the microcomputer can receive signals.
- 3. Received data is displayed on an array of 7-segment LEDs as a 2-digit hexadecimal number (one byte). Pressing the pushbutton switch (SW1) shifts the display by one byte.
- 4. To return the microcomputer to the standby mode again, press the pushbutton switch (SW2).
- 5. In this sample task, the operating voltage (Vcc) and analog power supply voltage (AVcc) of the H8/38024 are both 3.3 V, the OSC clock frequency is 10 MHz when a ceramic resonator is used, and the watch clock frequency is 32.768 kHz.



Figure 1 Hardware Configuration



6. The infrared remote control receiver used in this task is a remote control receiver (model GP1UD281XK) manufactured by Sharp. The specifications are as follows:

A. Figure 2 is an internal block diagram of the infrared remote control receiver.



Figure 2 Internal Block Diagram

- B. Characteristics of the GP1UD281XK are listed below.
  - a. Power supply voltage range: 2.7 to 5.5 V
  - b. Carrier frequency: 38 kHz
  - c. Internal demodulator compatible with pulse position modulation (PPM)
- 7. The circuit in this sample task operates as follows.
  - A. The microcomputer first operates in the standby mode, then in the active mode, and finally in the standby mode.
  - B. Infrared signals transmitted from the infrared remote controller are received and demodulated by the infrared remote control receiver. The first several signals are used to start the acceptance of an interrupt on the microcomputer.
  - C. When the interrupt is accepted, the oscillation waveform of the microcomputer starts changing. When the time specified for the "oscillation stabilization time" of AC characteristics has elapsed, the system clock starts operating.
  - D. After that, when the "waiting time" (8 to 16,384 states) has elapsed, the standby mode is released. Interrupt exception handling starts and the microcomputer shifts to the active mode.
  - E. When the "oscillation stabilization waiting time" has elapsed after the interrupt is accepted, the microcomputer shifts from the standby mode to the active mode.
  - F. The operation of the circuit in this sample task was checked with the waiting time set to 16 states. Figure 3 shows the definition of the waiting time.

oscillation-stabilization-waiting-time = oscillation-stabilization-time + waiting-time

- G. The microcomputer shifting to the active mode receives subsequent signals.
- H. Received data is displayed using two 7-segment LEDs. The data is displayed as a 2-digit hexadecimal number (one byte). Each time the pushbutton switch (SW1) is pressed, fetched data is shifted by two digits (one byte) and the next data is displayed.
- I. The data of the infrared remote controller used in this sample task consists of 4 bytes (= 32 bits) and is displayed as follows:

 $['H50] \rightarrow ['HAF] \rightarrow ['H17] \rightarrow ['HE8] \rightarrow [--] \quad (=End)$ 

(Each manufacturer does not release remote control codes. The above data shows the result of handling data byte by byte (8 bits) with conforming to the LSB first format, which is a general remote control signal format.)



- J. After received data has been displayed, pressing the pushbutton switch (SW2) as required places the microcomputer in the standby mode, that is, the status waiting for a remote control signal.
- K. For your information, the received data is represented in binary as follows. The bit-inverted value of byte 1 is byte 2 and the bit-inverted value of byte 3 is byte 4.



['H50] (=0101 0000), ['HAF] (=0101 1111), ['H17] (=0001 0111), ['HE8] (=1110 1000)

Figure 3 Oscillation Stabilization Waiting Time





Figure 4 Method of Controlling 7-Segment LEDs



8. In this sample task, the remote control input result is displayed on the 7-segment LED array as a hexadecimal number (H'FF to H'00). Figure 5 shows how the remote control input result is displayed on the LEDs.



Figure 5 Method of Displaying the Remote Control Input Result on the LEDs



#### 2. Description of Functions

1. Figure 6 is a block diagram of the H8/38024 functions used in this sample task. Table 1 is a list of the function assignments.



Figure 6 Block Diagram of Functions Used



Function	Description
Timer FL	The output compare function is used to input the infrared remote control data from the P41 input pin at intervals of 0.1 ms.
Timer C	The interval function is used to control the switching between the 7-segment LEDs. Each of the two 7-segment LEDs is lit in sequence at intervals of 3.2768 ms (the time at which timer C overflows), enabling dynamic illumination of the LED.
Port 4	Infrared remote control data is received at the P41 input pin and P43 (IRQ0 interrupt) is used to shift the mode from standby to active (high-speed).
Port 5	The P50 to P57 output pins are used to display data on the currently active 7-segment LED. The remote control data from the P41 pin is converted to 2-digit hexadecimal display data and output to the LEDs.
Port 6	P61 and P60 are turned on and off alternately to light the two 7-segment LEDs respectively.
	Pressing the display digit change SW (P62) displays input remote control codes consisting of multiple bytes in sequence. Pressing the standby SW (P63) shifts the mode from active (high-speed) to standby.

#### Table 1 Assignment of Functions

2. Figure 7 is a connection diagram of a 7-segment LED used. Outputting a high level from port 5 lights the corresponding segments of the LED, as shown in the figure. Table 2 is a list of the relationships between port 5 outputs and data on the LED display.



Figure 7 Connection Diagram and Internal Wiring of a 7-Segment LED



#### Table 2 Relationship between Port 5 Outputs and 7-Segment LED Display Data

LED			Po	rt 5 ou	tput d	ata			LED			Ро	rt 5 ou	tput d	ata		
display	P57	P56	P55	P54	P53	P52	P51	P50	display	P57	P56	P55	P54	P53	P52	P51	P50
	1	1	1	1	1	1	0	0		1	1	1	0	1	1	1	0
	0	1	1	0	0	0	0	0		0	0	1	1	1	1	1	0
	1	1	0	1	1	0	1	0		1	0	0	1	1	1	0	0
	1	1	1	1	0	0	1	0		0	1	1	1	1	0	1	0
	0	1	1	0	0	1	1	0		1	0	0	1	1	1	1	0
	1	0	1	1	0	1	1	0		1	0	0	0	1	1	1	0
	1	0	1	1	1	1	1	0									
	1	1	1	0	0	1	0	0									
B	1	1	1	1	1	1	1	0									
	1	1	1	1	0	1	1	0									

#### 3. Principles of Operation

1. Figure 8 shows how remote control signals are received using timer FL. The operating mode is set to standby, and infrared remote control signals are input from P41. An IRQO interrupt generated upon receiving the signals shifts the MCU mode to active (high-speed) and timer FL interrupts generated at intervals of 0.1 ms are used to input the infrared signal state.



Figure 8 Description of Receiving Remote Control Signals Using Timer FL



2. The following describes the operation of 7-segment LED display control. Figure 9 shows how a value of "50" is displayed on LED2 and LED1. As shown in the figure, each of LED1 and LED2 is lit in sequence at timer C overflow intervals, enabling dynamic display on the 7-segment LED.



Figure 9 Description of 7-Segment LED Display Control



#### 4. Description of Software

#### 1. Description of modules

Table 3 is a list of the modules used in this sample task.

#### Table 3 Description of Modules

Module Name	Label Name	Function
Main routine	main	After making the initial settings, shifts the mode to standby, waits for the completion of data fetching, and performs code decision processing and LED display processing repeatedly.
Code decision processing	code_decision	Extracts the code section from data input from the remote controller.
LED display processing	led_disp	Displays input remote control codes consisting of multiple bytes in sequence when the display switching SW is on. Shifts the mode from active (high-speed) to standby when the standby SW is on.
Software delay processing	delay	Used as a software timer which measures about 300 ms.
IRQ0 interrupt processing	irq0	Disables an IRQ0 interrupt.
Timer C interrupt processing	tmrc	Clears the interrupt flag, outputs the LED display data, and controls LED display switching.
Timer F interrupt processing	tmrf	Clears the interrupt flag and inputs the infrared signal state.

2. Description of arguments

No arguments are used in this sample task.

3. Description of internal registers

Table 4 is a list of the internal registers used in this sample task.



Regist	er Name	Description	Address	Setting
TCRF		Timer control register F:	H'FFB6	H′66
		Switches between the 16- and 8-bit modes, selects among four		
		types of internal clocks and an external event, and sets the output		
		levels of the TMOFH and TMOFL pins.		
	TOLH	Toggle output level H:	Bit 7	0
		Sets the output level of the TMOFH pin.		
		When TOLH = 0, the level is low.		
	CKSH2	Clock select H:	Bit 6	1
	CKSH1	When $CKSH2 = 1$ , $CKSH1 = 1$ , and $CKSH0 = 0$ , counting is	Bit 5	1
	CKSH0	performed using an internal clock of $\phi/4$ .	Bit 4	0
	TOLL	Toggle output level L:	Bit 3	0
		Sets the output level of the TMOFL pin.		
		When TOLL = 0, the level is low.		
	CKSL2	Clock select L:	Bit 2	1
	CKSL1	When $CKSL2 = 1$ , $CKSL1 = 1$ , and $CKSL0 = 0$ , counting is	Bit 1	1
	CKSL0	performed using an internal clock of $\phi/4$ .	Bit 0	0
TMC		Timer mode register C:	H'FFB4	H'1B
		Selects the automatic reload function, controls count-up or count-		
		down of the counter, and selects an input clock.		
	TMC7	Automatic reload function selection:	Bit 7	0
		Selects the automatic reload function of timer C.		
		When TMC7 = 0, the interval function is selected.		
	TMC6	Counter-up/down control:	Bit 6	0
	TMC5	Selects the up-counter or down-counter function.	Bit 5	0
		When TMC6 = 0 and TMC5 = 1, the TCC functions as an up-		
		counter.		
	TMC2	Clock select:	Bit 2	0
	TMC1	Selects a clock to be input to the TCC.	Bit 1	1
	TMC0	When TMC2 = 0, TMC1 = 1, and TMC0 = 1, counting is performed	Bit 0	1
		using an internal clock of $\phi/64$ .		
TLC		Timer load register C:	H'FFB5	H′00
		Sets the TCC reload value.		



Registe	r Name	Description	Address	Setting
TCSRF		Timer control/status register F:	H'FFB7	H′01
		Specifies whether to enable or disable counter clearing, sets the		
		overflow flag and compare match flag, and specifies whether to		
		enable or disable an interrupt request due to an overflow.		
	OVFH	Timer overflow flag H:	Bit 7	0
		Status flag indicating that TCFH overflow has occurred (H'FF $\rightarrow$ H'00)		
	CMFH	Compare match flag H:	Bit 6	0
		Status flag indicating that the values of TCFH and OCRFH match		
	OVIEH	Timer overflow interrupt enable H:	Bit 5	0
		When OVIEH = 0, an interrupt request due to a TCFH overflow is disabled.		
	CCLRH	Counter clear H:	Bit 4	0
		When CCLRH = 1, TCF clearing due to a compare match is enabled.		
	OVFL	Timer overflow flag L:	Bit 3	0
		Status flag indicating that TCFL overflow has occurred (H'FF $\rightarrow$ H'00)		
	CMFL	Compare match flag L:	Bit 2	0
		Status flag indicating that the values of TCFL and OCRFL match		
	OVIEL	Timer overflow interrupt enable L:	Bit 1	0
		When OVIEL = 0, an interrupt request due to a TCFL overflow is disabled.		
	CCLRL	Counter clear L:	Bit 0	1
		When CCLRL = 1, TCFL clearing due to a compare match is enabled.		
TCFL		8-bit timer counter:	H'FFB9	H′00
		8-bit read/write up-counter		
OCRFL		8-bit output compare register:	H'FFBB	H'7D
		Generates an interrupt due to a TCFL compare match.		



IENR1 - IENR2	IEN0	Interrupt enable register 1	H'FFF3	H′01 (At initial
- IENR2	IEN0			(At initial
- IENR2	IEN0			•
IENR2	IEN0			setting)
IENR2		When IEN0 = 1, an $\overline{IRQ0}$ pin interrupt request is enabled.	Bit 0	1/0
		Interrupt enable register 2	H'FFF4	H′00
				(At initial
_				setting)
_	IENTFL	When IENTFL = 1, a timer FL interrupt request is enabled.	Bit 2	1/0
	IENTC	When IENTC = 1, a timer C interrupt request is enabled.	Bit 1	1/0
IRR1		Interrupt request register 1	H'FFF6	H′00
				(At initial
_				setting)
	IRRI0	When IRRI0 = 1, this bit can be cleared by writing 0 in it.	Bit 0	1/0
		This bit is set to 1 when the $\overline{IRQ0}$ pin is set to the interrupt		
		input and the designated signal edge is input.		
IRR2		Interrupt request register 2	H'FFF7	H′00
				(At initial
_				setting)
	IRRTFL	When IRRTFL = 1, this bit can be cleared by writing 0 in it.	Bit 2	1/0
		This bit is set to 1 when the values of TCFL and OCRFL		
_		match in the 8-bit timer mode.		
	IRRTC	When $IRRTC = 1$ , this bit can be cleared by writing 0 in it.	Bit 1	1/0
		This bit is set to 1 when the counter value of timer C		
		overflows (H'FF $\rightarrow$ H'00) or underflows (H'00 $\rightarrow$ H'FF).		
SYSCR1		System control register 1:	H'FFF0	H'F7
_		Controls the power down mode.		
	SSBY	Software standby:	Bit 7	1
		1: Executes the SLEEP instruction in the active mode and		
_		shifts the mode to standby or watch.		
	STS2	Standby timer select 2 to 0:	Bit 6	1
_	STS1	7: Sets the waiting time to 16 states.	Bit 5	1
	STS0		Bit 4	1
-	LSON	Low-speed on flag:	Bit 3	0
		0: Uses the system clock ( $\phi$ ) as the CPU operating clock.		
			Bit 1	4
-	MA1	Active (medium-speed) mode clock select:	DILI	1



Register Name	Description	Address	Setting
PDR4	Port data register 4:	H'FFD7	H′00
	General I/O port data register for port 4		
PCR4	Port control register 4:	H'FFE7	H′00
	Specifies, bit by bit, whether to use each of the port 4 pins to be		
	used as general I/O ports as an input pin or output pin.		
	When PCR4 = H'00, the P47 to P40 pins function as general		
	input pins.		
PDR5	Port data register 5:	H'FFD8	H'00
	General I/O port data register for port 5		
PCR5	Port control register 5:	H'FFE8	H'FF
	Specifies, bit by bit, whether to use each of the port 5 pins to be		
	used as general I/O ports as an input pin or output pin.		
	When PCR5 = H'FF, the P57 to P50 pins function as general		
	output pins.		
PDR6	Port data register 6:	H'FFD9	H′03
	General I/O port data register for port 6		
PCR6	Port control register 6:	H'FFE9	H′03
	Specifies, bit by bit, whether to use each of the port 6 pins to be		
	used as general I/O ports as an input pin or output pin.		
	When PCR6 = H'03, the P61 and P60 pins function as general		
	output pins and the P67 to P62 pins function as general input		
	pins.		



#### 4. RAM usage

Table 5 describes RAM usage in this sample task.

Label name	Description	Address	Module label name
dig_0	Stores LED1 display data (1 byte).	H'FB86	led_disp, tmrc
dig_1	Stores LED2 display data (1 byte).	H'FB87	led_disp, tmrc
cnt	8-bit counter for switching display LED1 and LED2 (1 byte)	H'FB88	tmrc
i	Stores the loop counter value (2 bytes).	H'FB80	code_decision, delay
ptr	Pointer used for switching display LED1 and LED2 (2 bytes)	H'FB82	tmrc
dcnt	Receive bit data counter (2 bytes)	H'FB84	main, tmrf
data	Stores bit data at reception (700 bytes).	H′FB89	code_decision, tmrf
leddata	Stores the code section extracted from the bit data (100 bytes).	H'FE45	code_decision, led_disp
led_cnt	Stores the display digit of leddata (1 byte).	H'FEAA	led_disp
bit_cnt	Stores the on/off bit position (1 byte).	H'FEAB	code_decision
pulse_cnt	Counts the high level of each pulse (1 byte).	H'FEAC	code_decision
byte_cnt	Counts the number of leddata items (1 byte).	H'FEAD	code_decision, led_disp

#### Table 5 Description of RAM



#### 5. Flowchart

1. Main routine (main)









2. Code decision processing (code\_decision)









3. LED display processing (led\_disp)









4. Software delay processing (delay)





5.  $\overline{\text{IRQ0}}$  interrupt processing (irq0)





6. Timer C interrupt processing (tmrc)





7. Timer F interrupt processing (tmrf)





#### 6. Program Listing

INIT.SRC (program listing)

```
.export _INIT
   .import __main
;
   .section P,CODE
_INIT:
  mov.w #h'ff80,r7
  ldc.b #b'1000000,ccr
  jmp @_main
;
   .end
/* Super Low Power Series -H8/38024- Application note */
/* Application example */
/* Remote control */
#include <machine.h>
/* Symbol Definition */
struct BIT {
  unsigned char b7:1;
                          /* bit 7 */
  unsigned char b6:1;
                           /* bit 6 */
  unsigned char b5:1;
                            /* bit 5 */
  unsigned char b4:1;
                          /* bit 4 */
  unsigned char b3:1;
                           /* bit 3 */
                            /* bit 2 */
  unsigned char b2:1;
  unsigned char b1:1;
                           /* bit 1 */
  unsigned char b0:1;
                            /* bit 0 */
};
#define H
           1
                                                    /* High Level */
#define L
           0
                                                    /* Low Level */
#define MAXBITDATA
                                                    /* max bit data size */
                    700
#define MAXLEDDATA
                    100
                                                    /* max led data size */
#define PDR4
              *(volatile unsigned char *)0xFFD7
                                                    /* Port data register 4 */
#define PCR4 *(volatile unsigned char *)0xFFE7
                                                    /* Port control register 4
*/
#define PMR2 *(volatile unsigned char *)0xFFC9
                                                    /* Port mode register 2 */
#define PMR5
               *(volatile unsigned char *)0xFFCC
                                                    /* Port mode register 5 */
#define PUCR5 *(volatile unsigned char *)0xFFE2
                                                    /* Port pull-up control
register 5 */
                                                    /* Port data register 5 */
#define PDR5
              *(volatile unsigned char *)0xFFD8
#define PCR5
              *(volatile unsigned char *)0xFFE8
                                                    /* Port control register 5
*/
#define PDR6 *(volatile unsigned char *)0xFFD9
                                                    /* Port data register 6 */
#define PDR6_BIT (*(struct BIT *)0xFFD9)
#define STANDBY PDR6_BIT.b3
                                                    /* standby switch */
```



/\* LED figure switch \*/ #define FIGURE PDR6 BIT.b2 #define LED\_H PDR6\_BIT.b1 /\* LED(HIGH) ON/OFF \*/ #define LED L PDR6 BIT.b0 /\* LED(LOW) ON/OFF \*/ #define PCR6 \*(volatile unsigned char \*)0xFFE9 /\* Port control register 6 \*/ #define TCRF \*(volatile unsigned char \*)0xFFB6 /\* timer control register F \*/ #define TCSRF \*(volatile unsigned char \*)0xFFB7 /\* timer control status register F \*/ #define TCSRF\_BIT (\*(struct BIT \*)0xFFB7) #define CMFL TCSRF BIT.b2 /\* Compare-Match Flag L \*/ #define TCFL \*(volatile unsigned char \*)0xFFB9 /\* 8 bit timer counter F(LOW) \*/ #define OCRFL \*(volatile unsigned char \*)0xFFBB /\* 8 bit output compare register F(LOW) \*/ #define TMC \*(volatile unsigned char \*)0xFFB4 /\* Timer mode register C \*/ #define TLC \*(volatile unsigned char \*)0xFFB5 /\* Timer Load register C \*/ #define IENR1 \*(volatile unsigned char \*)0xFFF3 /\* Interrupt enable register 1 \*/ #define IENR1 BIT (\*(struct BIT \*)0xFFF3) #define IEN0 IENR1\_BIT.b0 /\* IRQ0 interrupt enable \*/ #define IRR1 \*(volatile unsigned char \*)0xFFF6 /\* Interrupt request register 1 \*/ #define IRR1\_BIT (\*(struct BIT \*)0xFFF6) #define IRRI0 IRR1\_BIT.b0 /\* IRQ0 interrupt request flag \*/ #define IENR2 \*(volatile unsigned char \*)0xFFF4 /\* interrupt enable register 2 \*/ #define IENR2 BIT (\*(struct BIT \*)0xFFF4) #define IENTFL IENR2\_BIT.b2 /\* Timer FL interrupt enable \*/ #define IENTC IENR2\_BIT.b1 /\* Timer C interrupt enable \*/ #define IRR2 \*(volatile unsigned char \*)0xFFF7 /\* interrupt request register 2 \*/ #define IRR2\_BIT (\*(struct BIT \*)0xFFF7) #define IRRTFL IRR2\_BIT.b2 /\* Timer FL interrupt enable \*/ #define IRRTC IRR2\_BIT.b1 /\* Timer C interrupt request flag \*/ #define SYSCR1 \*(volatile unsigned char \*)0xFFF0 /\* system control register 1 \*/ #define SYSCR2 \*(volatile unsigned char \*)0xFFF1 /\* system control register 2 \*/

```
#pragma interrupt (irq0)
#pragma interrupt (tmrc)
#pragma interrupt (tmrf)
/* Function define */
extern void INIT(void);
void main(void);
void code_decision(void);
void led_disp(void);
void delay(void);
void irq0(void);
void tmrc(void);
void tmrf(void);
/* Data table */
const unsigned char dsp_data[16] =
{
   0x3f,
    0x06,
    0x5b,
    0x4f,
    0x66,
    0x6d,
    0x7d,
    0x27,
    0x7f,
    0x6f,
    0x77,
    0x7c,
    0x39,
    0x5e,
    0x79,
    0x71
};
/* RAM define */
unsigned char dig_0;
*/
unsigned char dig_1;
* /
unsigned char cnt;
int i;
unsigned char *ptr;
int dcnt;
unsigned char data[MAXBITDATA];
unsigned char leddata[MAXLEDDATA];
unsigned char led cnt;
unsigned char bit_cnt;
unsigned char pulse_cnt;
unsigned char byte_cnt;
/* Vector address */
#pragma section V1
void (*const VEC_TBL1[])(void) = {
```

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```
/* Stack pointer set */
/* main routine */
/* code decision routine */
/* LED display routine */
/* delay routine */
/* IRQ0 routine */
/* Timer C interrupt routine */
/* Timer F interrupt routine */
/* LED display data = "0" */
/* LED display data = "1" */
/* LED display data = "2" */
/* LED display data = "3" */
/* LED display data = "4" */
/* LED display data = "5" */
/* LED display data = "6" */
/* LED display data = "7" */
/* LED display data = "8" */
/* LED display data = "9" */
/* LED display data = "A" */
/* LED display data = "B" */
/* LED display data = "C" */
/* LED display data = "D" */
/* LED display data = "E" */
/* LED display data = "F" */
/* Dig-0 LED display data store
/* Dig-1 LED display data store
/* LED enable counter */
/* loop counter */
/* Pointer set */
/* read data counter */
/* read data(bit data) */
/* read data(led data) */
/* led display counter */
/* 8bit counter */
/* pulse counter */
/* byte counter */
/* Vector section set */
```

# RENESAS .

/\* H'0000 Reset vector \*/ INIT }; /\* Vector section set \*/ #pragma section V2 void (\*const VEC\_TBL2[])(void) = { /\* H'0008 IRQ0 vector \*/ irq0 }; #pragma section V3 /\* Vector section set \*/ void (\*const VEC\_TBL3[])(void) = { tmrc /\* H'001a Timer C interrupt vector \*/ }; /\* Vector section set \*/ #pragma section V4 void (\*const VEC\_TBL4[])(void) = { /\* H'001c Timer F interrupt tmrf vector \*/ }; /\* P \*/ #pragma section /\* Main program \* , void main(void) { /\* CCR I-bit = 1 \*/ set\_imask\_ccr(1); PCR5 = 0xFF;/\* Initialize : output LED \*/ PDR5 =  $0 \times 00;$ /\* LED clear \*/ PCR6 = 0x03;/\* Initialize : input SW & LED control\*/ PDR6 =  $0 \times 03$ ; /\* LED OFF \*/ SYSCR1 =  $0 \times F7$ ; /\* standby mode, 16 state \*/ /\* Initialize : use IRQ0 \*/ PMR2 = 0xD9;/\* clear IRQ0 interrupt request IRRIO = 0;flag \*/ TCRF = 0x66;/\* Set intrernal clock :  $f \acute{O}/4$  \*/ TCSRF = 0x01;/\* Enable TCFL clear \*/  $TCFL = 0 \times 00;$ /\* clear Timer Counter FL to 0 \*/ OCRFL = 0x7D;/\* set interrupt interval to 0.1msec \*/ IENTFL = 0;/\* Timer FL interrupt disable \*/ IENTC = 0;/\* Timer C interrupt disable \*/ while(1){ IEN0 = 1;/\* IRQ0 enable \*/ dcnt = 0;/\* clear read data count \*/ /\* CCR I-bit = 0 \*/ set\_imask\_ccr(0);

#### H8/300L SLP Series Example of Receiving Remote Control Signals in Power-Saving Modes

```
/* standby */
     sleep();
     IENTFL = 1;
                                         /* enable interrupt request FL
* /
     while(dcnt < MAXBITDATA);</pre>
     code_decision();
                                        /* code decision routine */
     led_disp();
                                         /* LED display routine */
  }
}
/*
                                                    * /
    code decision routine
void code_decision(void)
{
  i = 0;
  while(data[i++] == 0);
                                         /* Leader Code */
                                         /* then leader cord follows */
  if(i > 21)
     while(data[i++]);
                                         /* Leader Code */
  else
                                         /* else data code */
     i = 1;
                                         /* initialize index */
  bit_cnt = 0x01;
                                         /* set bit counter to LSB */
  pulse_cnt = 0;
                                         /* pulse counter to zero clear
* /
  byte cnt = 0;
                                         /* byte counter to zero clear */
  for(i=i-1;i<MAXBITDATA;i++){</pre>
     if(data[i] == L){
                                         /* Low ? */
        if(pulse_cnt){
          if(pulse_cnt > 12)
             leddata[byte cnt] |= bit cnt; /* bit on */
          else
             leddata[byte_cnt] &= ~bit_cnt; /* bit off */
          bit_cnt <<= 1;</pre>
                                         /* bit shift */
          if(!bit_cnt){
                                         /* next byte ? */
             bit_cnt = 0x01;
                                         /* set bit counter to LSB */
             byte cnt++;
                                         /* count up */
          }
          pulse_cnt = 0;
                                         /* pulse counter to zero clear
* /
        }
     } else {
                                         /* High */
       pulse_cnt++;
                                         /* count up */
        if(pulse_cnt > 25)
          break;
     }
  }
}
/*
     LED display routine
                                                    */
```

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void led\_disp(void) { TLC =  $0 \times 00$ ; /\* Clear Timer Load register C to 0 \*/ /\* Timer C TMC = 0x1B;initialize \*/ IRRTC = 0;/\* Clear IRRTC to 0 \*/ IENTC = 1;/\* Timer C interrupt enable \*/ led cnt = 0;dig\_0 = dsp\_data[leddata[led\_cnt] & 0x0F]; /\* Dig-0 LED display data set \*/ dig\_1 = dsp\_data[leddata[led\_cnt] >> 4 & 0x0F]; /\* Dig-1 LED display data set \*/ while(1){ if(STANDBY){ /\* standby switch ON ? \*/ delay(); /\* Timer C IENTC = 0;interrupt disable \*/ IRRIO = 0;/\* clear IRQ0 interrupt request flag \*/ PDR6 =  $0 \times 03;$ /\* LED OFF \*/ break; } else if(FIGURE){ /\* LED figure switch ON ? \*/ if(byte\_cnt > led\_cnt) led\_cnt++; /\* next byte \*/ else led cnt = 0;/\* start byte \*/ if(byte\_cnt == led\_cnt){  $dig_0 = 0x40;$ /\* Dig-0 LED display data set(-) \*/  $dig_1 = 0x40;$ /\* Dig-1 LED display data set(-) \*/ } else { display data set \*/ dig\_1 = dsp\_data[leddata[led\_cnt] >> 4 & 0x0F]; /\* Dig-1 LED display data set \*/ } delay(); } } } delay routine(about 300msec) \* / 



```
void delay(void)
{
  long i;
  for(i = 0; i < 20000; i++)
    nop();
}
*/
/* Interrupt Request 0
void irq0(void)
{
  IEN0 = 0;
                                 /* IRQ0 disable */
}
/* Timer C Interrupt(in order to light LED in turn)
                                         */
void tmrc(void)
{
  IRRTC = 0;
                                 /* Clear IRRTC to 0 */
  ptr = &dig_0;
                                 /* LED display data store
address set */
  ptr += cnt;
                                 /* LED display data read */
  PDR5 = *ptr;
                                 /* LED display data output */
  if(!cnt){
   LED L = 0;
                                 /* LED(LOW) ON */
   LED H = 1;
                                 /* LED(HIGH) OFF */
  } else {
                                 /* LED(HIGH) ON */
   LED_H = 0;
                                 /* LED(LOW) OFF */
    LED_L = 1;
  }
                                 /* "cnt" increment */
  cnt++;
  if (cnt >= 2){
                                 /* 2 times end ? */
    cnt = 0;
                                 /* "cnt" initialize */
  }
}
/* Timer F Interrupt(every 0.1msec)
                                          */
void tmrf(void)
{
  if(PDR4 & 0x02)
    data[dcnt++] = 1;
                                /* bit ON */
  else
    data[dcnt++] = 0;
                                 /* bit OFF */
  if(dcnt == MAXBITDATA){
                                 /* end ? */
    IENTFL = 0;
                                 /* disable interrupt request FL
* /
```

NESA



ounter FL to 0
match flag A */
n



#### **Revision Record**

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